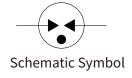


FEATURES

| Surface Mounting Design 4.5*3.2*2.7mm
| High Current Handling Capability 2000A @ 8/20 µs
| Low Capacitance and Insertion Loss
| Quick Response and Long Service Life
| Moisture sensitivity level: Level 1
| High Reliability and Automobile Grade(AEC-Q200)





APPLICATION INFORMATION

Communication equipment.	
Repeaters, Modems	
Telephone Interface,Line cards.	
Data communication equipment.	
Automobile Lighting	

AGENCY APPROVALS

lcon	Solderability	
RoHS	Compliance with 2011/65/EU	
HF	Compliance with IEC61249-2-21:2003	
₽	Mean lead free	
<i>1</i> R .	UL Certificated E505857	

PRODUCT CHARACTERISTICS

Lead Material	Body Material	Terminal Finish
Copper or Fe-Ni alloy	Ceramics	100% Matte-Tin Plated



ELECTRICAL PARAMETER

Parameter	Condition	Rating	Unit
DC Blocking Voltage 1)	100V/s	72-108	
Impulse Spark-over Voltage	At 1kV/μs	for 99 % of measured values ≤ 700	V
impuise Spaik-over voltage	At 1kV/μs	Typical values of distribution ≤ 600	V
Impulse Discharge Current 2)	8/20µs	2000	А
Insulation Resistance	DC=50V	≥1	GΩ
Capacitance at 1MHz	V _{DC} =0.5V	≤ 1.0	pF
Operating And Storage Temperature		-40-125	°C

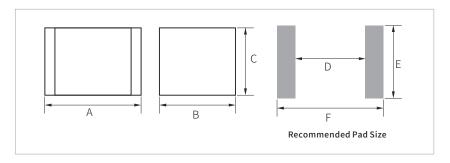
¹⁾ In ionized mode

ENVIRONMENTAL RELIABILITY CHARACTERISTICS

Testing items	Technical standards	
High Temperature Storage Test	Temperature: 85°C; Time:2H	
Low Temperature Storage Test	Temperature: -40°C; Time:2H	
Vibration	Frequency: 10-500Hz ; Amplitude: 0.15mm ; Time: 45min	
Resistance of soldering heat	Temperature: 260±5°C; Time of dip soldering: 10s, 1time	

NOTE: Up-screen program can be specified by customer's request via contacting Semiware service

DIMENSIONS AND RECOMMENDED SOLDERING PAD



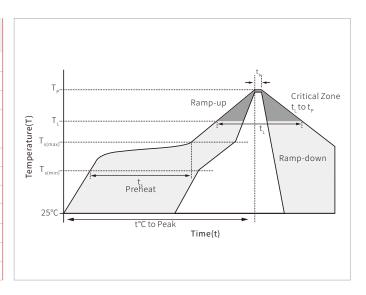
Ref.	mm	
А	4.5±0.3mm	
В	3.2±0.3mm	
С	2.7±0.3mm	
D	2.8mm	
E	4.0mm	
F	5.2mm	

²⁾ Terms and waveforms in accordance with ITU-T Rec. K. 12; IEC 61643-311 $\,$



REFLOW PROFILE

Reflow Condition		Lead-free assembly	
	Temperature Min	150°C	
Pre Heat	Temperature Max	200°C	
	Time(min to max)	60 – 180 secs	
Average ra	mp up rate (Liquidus) Temp (T_L) to peak	3°C/second max	
	$T_{s(max)}$ to T_{L} - Ramp-up Rate		
D (1	Temperature (T _L) (Liquidus)	217°C	
Reflow	$Time(min to max)(t_s)$	60 – 150 seconds	
Peak Ten	nperature (T,)	260 °C	
Time within 5°C of actual peak Temperature (tp)		20-40 seconds	
Ramp-down Rate		6°C/second max	
Time 25°C to peak Temperature (T₂)		8 minutes max.	
Do not exceed		260°C	



ORDERING INFORMATION

Part Number	Size	QTY/Reel	Reel Size
TPSG4532B090	4.5*3.2*2.7mm	2500PCS	13"



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By QR Code





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Wechat

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